

**COIL FORMERS****General data SMD coil former**

PARAMETER	SPECIFICATION
Coil former material	phenolformaldehyde (PF), glass-reinforced, flame retardant in accordance with "UL 94V-0"; UL file number E41429 (M)
Solder pad material	copper-tin alloy (CuSn), tin (Sn) plated.
Maximum operating temperature	155 C, "IEC 60085", class F
Resistance to soldering heat	"IEC 60068-2-20", Part 2, Test Tb, method 1B, 350 C, 3.5 s
Solderability	"IEC 60068-2-20", Part 2, Test Ta, method 1

**Winding data for RM4/ILP coil former (SMD)**

NUMBER OF SECTIONS	NUMBER OF SOLDER PADS	WINDING AREA (mm <sup>2</sup> )	WINDING WIDTH (mm)	AVERAGE LENGTH OF TURN (mm)	TYPE NUMBER
1	8	3.75	3.0	20.7	CSVS-RM4/LP-1S-8PL